

InAsSb photovoltaic detectors

P16112/P16612/P16849 series (with band-pass filter)

Back-illuminated type infrared detectors with band-pass filter (3.3 μ m, 3.9 μ m, 4.26 μ m, 4.45 μ m)

These are InAsSb photovoltaic detectors that use a band-pass filter for the window material. By using a back-illuminated structure, we greatly improved the sensitivity temperature coefficient compared to the front-illuminated type. Types using a band-pass filter with a center wavelength of 3.3 μ m, 3.9 μ m, or 4.26 μ m are suitable for gas measurement, and a type using a band-pass filter of 4.45 μ m is suitable for flame monitoring. These are environmentally friendly infrared detectors and do not use lead, mercury, or cadmium, which are substances restricted by the RoHS directive. A two-element type that can detect two wavelength is also available.

Features

- ➡ High sensitivity
- **■** High-speed response
- → High shunt resistance
- Compact, surface mount ceramic package
- Compatible with lead-free solder reflow (ceramic package)

- Applications

- **☐** Gas measurement (CH4, CO2)
- **▶** Flame monitors (CO₂ resonance radiation)
- Option (sold separately)
- **■** Amplifier for infrared detector

C4159-01

Structure

Type no.	Number of elements	Photosensitive area (mm)	Window material*1	Package	Cooling	Field of view FOV (degrees)
P16112-033MF		0.7 × 0.7	BPF (3.3 μm)	TO-46	Non-cooled	
P16112-039MF	2		BPF (3.9 μm)			87
P16112-043MF			BPF (4.26 µm)			67
P16112-045MF			BPF (4.45 µm)			
P16612-033CF			BPF (3.3 μm)	Ceramic		86
P16612-039CF			BPF (3.9 µm)			
P16612-043CF			BPF (4.26 μm)			
P16612-045CF			BPF (4.45 µm)			
P16849-011CF P16849-012CF			BPF (3.3 μm)			
			BPF (3.9 µm)			
			BPF (4.26 μm)			
			BPF (3.9 µm)			

^{*1:} BPF: Band-pass filter. For windowless and AR coating types, refer to the P16612-011CN datasheet.

♣ Absolute maximum ratings (Typ. Ta=25 °C, unless otherwise noted)

Type no.	Reverse voltage VR (V)	Operating temperature*2 Topr (°C)	Storage temperature*2 Tstg (°C)	Incident light level (W/mm²)	Soldering temperature Tsol (°C)
P16112-033MF					
P16112-039MF					
P16112-043MF					-
P16112-045MF					
P16612-033CF	1	-40 to +85	-40 to +85	1	
P16612-039CF	1	-40 10 +63	-40 (0 +63	1	
P16612-043CF					240 (twice)*3
P16612-045CF					240 (twice)
P16849-011CF					
P16849-012CF					

^{*2:} No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

= Electrical and optical characteristics (Typ. Ta=25 °C, unless otherwise noted)

Type no.	wa	Center velen CWL	gth	resp half v FW	width HM	Photosensitivity S λ=CWL	resistance Rsh	D	ctivity)* 1200, 1)	pov Ni	quivalent wer EP λρ	Rise time tr*4	Terminal capacitance Ct*5
	Min. (nm)		Max. (nm)		Max. (nm)		$VR=10 \text{ mV}$ $(k\Omega)$	Min. (cm·Hz ^{1/2} /W)	Typ. (cm·Hz ^{1/2} /W)	Typ. (W/Hz ^{1/2})	Max. (W/Hz ^{1/2})	(ns)	(pF)
P16112-033MF	3270	3300	3330	160	180	2.8		3.2×10^{8}	6.5×10^{8}	1.1×10^{-10}	2.2 × 10 ⁻¹⁰		
P16112-039MF	3820	3900	3980	90	110	3.2		3.7×10^{8}	7.4×10^{8}	9.5×10^{-11}	1.9×10^{-10}		
P16112-043MF	4217	4260	4303	140	160	3.2					1.9×10^{-10}		
P16112-045MF	4400	4450	4500	350	400	3.7		4.3×10^{8}	8.6×10^{8}	8.2×10^{-11}	1.6×10^{-10}		
P16612-033CF	3270	3300	3330	160	180	2.8		3.2×10^{8}	6.5×10^{8}	1.1×10^{-10}	2.2×10^{-10}		
P16612-039CF	3820	3900	3980	90	110	3.2	100	3.7×10^{8}	7.4×10^{8}	9.5×10^{-11}	1.9×10^{-10}	15	0.5
P16612-043CF	4217	4260	4303	140	160	3.2	180	3.7×10^8	7.4×10^{8}	9.5×10^{-11}	1.9×10^{-10}	15	0.5
P16612-045CF	4400	4450	4500	350	400	3.7		4.3×10^{8}	8.6×10^{8}	8.2×10^{-11}	1.6×10^{-10}		
P16849-011CF	3270	3300	3330	160	180	2.8		3.2×10^{8}	6.5×10^{8}	1.1×10^{-10}	2.2×10^{-10}		
P10049-011CF	3820	3900	3980	90	110	3.2		3.7×10^{8}	7.4×10^{8}	9.5×10^{-11}	1.9×10^{-10}		
D16940 012CE	4217	4260	4303	140	160	3.2		3.7×10^{8}	7.4×10^{8}	9.5×10^{-11}	1.9×10^{-10}		
P16849-012CF	3820	3900	3980	90	110	3.2		3.7×10^{8}	7.4×10^{8}	9.5 × 10 ⁻¹¹	1.9 × 10 ⁻¹⁰		

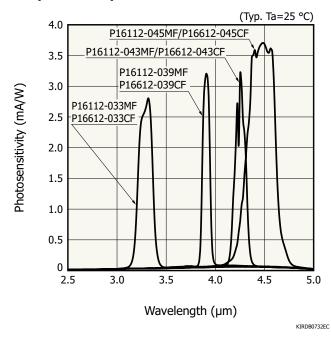
^{*4:} VR=0 V, RL=50 Ω , 10 to 90%



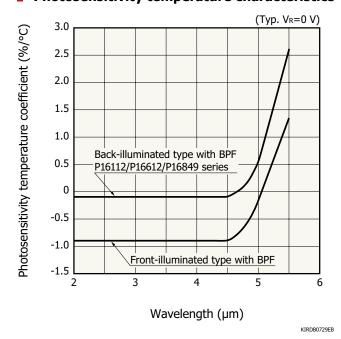
^{*3:} Reflow soldering, JEDEC J-STD-020 MSL 2, see P.8

^{*5:} VR=0 V, f=1 MHz

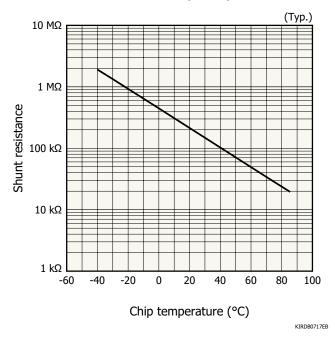
Spectral response



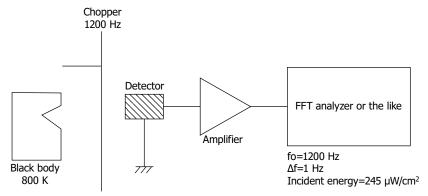
- Photosensitivity temperature characteristics



> Shunt resistance vs. chip temperature



Measurement circuit example



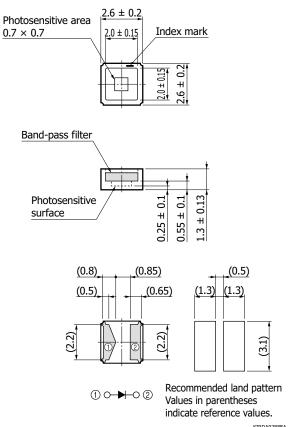
KIRDC0127EA

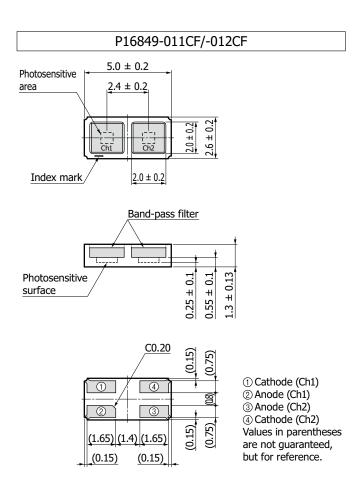
- Dimensional outlines (unit: mm)

P16112-033MF/-039MF/-043MF/-045MF

Photosensitive area 0.7×0.7 $\phi 5.4 \pm 0.2$ $\phi 4.6 \pm 0.2$ $.47 \pm 0.1$ Photosensitive surface 12.0 ± 0.5 φ0.45 $\phi 2.5 \pm 0.2$ ①Cathode ② Case ③ Anode Values in parentheses indicate reference values. KTRDA0284FA

P16612-033CF/-039CF/-043CF/-045CF





Recommended land pattern

(2.3) (0.9) (2.3)

Type no.	Ch1	Ch2	
P16849-011CF	3.3 µm	3.9 µm	
P16849-012CF	4.26 µm	3.9 µm	

KIRDA0287EA

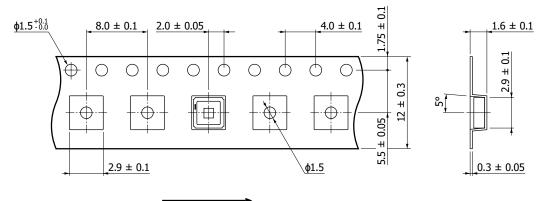
Standard packing specifications

P16612-033CF/-039CF/-043CF/-045CF

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ180 mm	ф60 mm	12 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



Reel feed direction



KLEDC0143EA

- Packing quantity500 pcs/reel
- Packing state

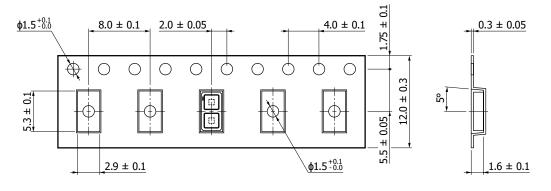
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

P16849-011CF/-012CF

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
ф180 mm	ф60 mm	12 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



Reel feed direction



KIRDC0146EA

- Packing quantity 100 pcs/reel
- Packing state

 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

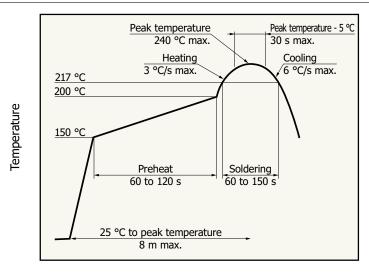
Recommended soldering conditions

P16112-033MF/-039MF/-043MF/-045MF

· Solder temperature: 260 °C (10 s or less, once) Solder the leads at a point at least 1 mm away from the package body.

Note: When you set soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

P16612-033CF/-039CF/-043CF/-045CF, P16849-011CF/-012CF



- After unpacking, store the device in an environment at a temperature range of 5 to 30 °C and a humidity of 60% or less, and perform reflow soldering within 1 year.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Time

KSPDB0418EA

- Related products





The M16953 is an evaluation amplifier for gas measurement used in combination with Hamamatsu's InAsSb photovoltaic devices with band-pass filters (TO-46 package). These can detect infrared light transmitted through a band-pass filter simply by connecting a power supply ± 2.5 V.

Specifications

- Applicable devices: InAsSb photovoltaic detectors with band-pass filter*6
- Gain: 10⁷ V/A
- Frequency characteristics: DC to 80 kHz
- → Recommended drive voltage: ±2.5 V

*6: InAsSb photovoltaic devices with band-pass filter sold separately

Evaluation kit M16615 for mid infrared LED



The M16615 is a driver for mid infrared LED (TO-46 package). The LED can be pulse-driven simply by connecting a power supply (+15 V). This is used in combination with the evaluation kit M16953 series for InAsSb photovoltaic detector.

Specifications

- Applicable devices: Mid infrared LED*7
- Output current: 400 mA
- **Output pulse: 10 μs**
- Dutput cycle: 1000 μs
- Recommended drive voltage: +15 V

*7: Mid infrared LED sold separately

InAsSb photovoltaic detectors

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer
- · Safety consideration / Opto-semiconductor products
- · Precautions / Surface mount type products
- · Precautions / Compound opto-semiconductors (photosensors, light emitters)
- Catalogs
- · Selection guide / Infrared detectors
- · Technical note / Compound semiconductor photosensors

Information described in this material is current as of March 2025.

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